PCN Number:		20191120000.0					PC	N Date:	Nov 21 2019
Title: Device ID symbolization change for the TAS5825MRHBR/T									
Customer Contact:		PCN Manager			Dept:	Quality Service	ality Services		
Change Type:									
Assembly Site				Assembly Process				Assembly Materials	
Design				Datasheet				Mechanical Specification	
Test Site			\boxtimes	Packing/Shipping/Labeling				Test Process	
Wafer Bump Site				Wafer Bump Material			Wafer Bump Process		
Wafer Fab Site				Wafer Fab Materials			Wafer Fab Process		
				Part number change					

PCN Details								
Description of Change:								
The device ID -	u wala a li a a ki a wala a T		ill be chemine of C ollevier					
The device ID symbolization for the TAS5825MRHBR/T will be changing as follows:								
	What	Current	New					
	Device ID Symolization	TAS 5825MBO	5825M					
Reason for Change:								
Symbolization s	standardization							
Anticipated in	npact on Fit, Form, F	unction, Quality	or Reliability (positive /	' negative):				
None								
Changes to pr	oduct identification	resulting from th	is PCN:					
Device symboli	zation							
Product Affect	ted:							
TAS5825MRHBR TAS5825MRHBT								

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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